

# RESIN SHEET FOR PACKAGING ELECTRONIC COMPONENT, AND ELECTRONIC COMPONENT PACKAGING CONTAINER USING SAME

## ABSTRACT

[Problem] To provide a resin sheet for electronic component packaging with transparency, excellent folding endurance, and also excellent low-temperature heat sealing property, and an electronic component packaging container using the resin sheet.

[Solution] A resin sheet for electronic component packaging, the resin sheet composed of a rubber-modified aromatic vinyl-based copolymer resin that includes rubber-type polymers (Y) as dispersed particles in a continuous matrix resin (X), and that satisfies (1) and (2) below:

(1) the continuous matrix resin (X) is a copolymer of 53-63 mass% of one or more aromatic vinyl-based compounds (x1) and 37-47 mass% of one or more (meth)acrylic acid alkyl esters (x2); and

(2) the ratio of the rubber-type polymers (Y) to the total mass of the rubber-modified aromatic vinyl-based copolymer resin is 5 mass% or more and less than 10 mass%.

[no suitable figure]